



**THE DATASHEET OF
MC14504BF**



MC14504B

Hex Level Shifter for TTL to CMOS or CMOS to CMOS

The MC14504B is a hex non-inverting level shifter using CMOS technology. The level shifter will shift a TTL signal to CMOS logic levels for any CMOS supply voltage between 5 and 15 volts. A control input also allows interface from CMOS to CMOS at one logic level to another logic level: Either up or down level translating is accomplished by selection of power supply levels V_{DD} and V_{CC} . The V_{CC} level sets the input signal levels while V_{DD} selects the output voltage levels.

Features

- UP Translates from a Low to a High Voltage or DOWN Translates from a High to a Low Voltage
- Input Threshold Can Be Shifted for TTL Compatibility
- No Sequencing Required on Power Supplies or Inputs for Power Up or Power Down
- 3 to 18 Vdc Operation for V_{DD} and V_{CC}
- Diode Protected Inputs to V_{SS}
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage Range	-0.5 to +18.0	V
V_{DD}	DC Supply Voltage Range	-0.5 to +18.0	V
V_{in}	Input Voltage Range (DC or Transient)	-0.5 to +18.0	V
V_{out}	Output Voltage Range (DC or Transient)	-0.5 to $V_{DD} + 0.5$	V
I_{in}, I_{out}	Input or Output Current (DC or Transient) per Pin	± 10	mA
P_D	Power Dissipation, per Package (Note 1)	500	mW
T_A	Ambient Temperature Range	-55 to +125	$^{\circ}\text{C}$
T_{stg}	Storage Temperature Range	-65 to +150	$^{\circ}\text{C}$
T_L	Lead Temperature (8-Second Soldering)	260	$^{\circ}\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: -7.0 mW/ $^{\circ}\text{C}$ From 65 $^{\circ}\text{C}$ To 125 $^{\circ}\text{C}$

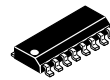
This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

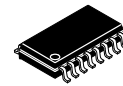


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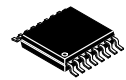
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SOIC-16
D SUFFIX
CASE 751B

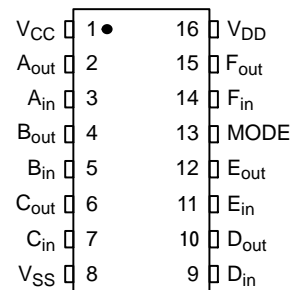


SOEIAJ-16
F SUFFIX
CASE 966

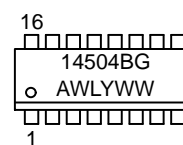


TSSOP-16
DT SUFFIX
CASE 948F

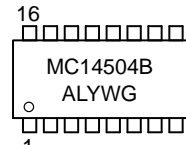
PIN ASSIGNMENT



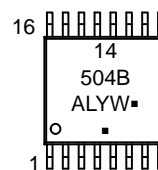
MARKING DIAGRAMS



SOIC-16



SOEIAJ-16



TSSOP-16

A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G or ■ = Pb-Free Indicator

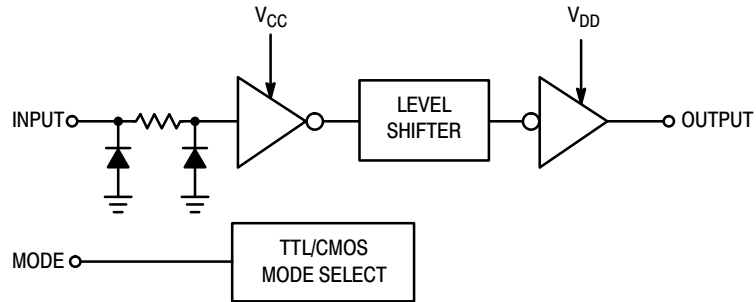
(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

MC14504B

LOGIC DIAGRAM



Mode Select	Input Logic Levels	Output Logic Levels
1 (V_{CC})	TTL	CMOS
0 (V_{SS})	CMOS	CMOS

1/6 of package shown.

ORDERING INFORMATION

Device	Package	Shipping [†]
MC14504BDG	SOIC-16 (Pb-Free)	48 Units / Rail
NLV14504BDG*		
MC14504BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
NLV14504BDR2G*		
MC14504BDTG	TSSOP-16 (Pb-Free)	96 Units / Rail
NLV14504BDTG*		
MC14504BDTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel
NLV14504BDTR2G*		
MC14504BFELG	SOEIAJ-16 (Pb-Free)	2000 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V_{CC} Vdc	V_{DD} Vdc	- 55°C		25°C			125°C		Unit
				Min	Max	Min	Typ (Note 2)	Max	Min	Max	
Output Voltage $V_{in} = 0$ V $V_{in} = V_{CC}$	"0" Level V_{OL}	-	5.0	-	0.05	-	0	0.05	-	0.05	Vdc
		-	10	-	0.05	-	0	0.05	-	0.05	
		-	15	-	0.05	-	0	0.05	-	0.05	
	"1" Level V_{OH}	-	5.0	4.95	-	4.95	5.0	-	4.95	-	Vdc
		-	10	9.95	-	9.95	10	-	9.95	-	
		-	15	14.95	-	14.95	15	-	14.95	-	
Input Voltage "0" Level ($V_{OL} = 1.0$ Vdc) TTL-CMOS ($V_{OL} = 1.5$ Vdc) TTL-CMOS ($V_{OL} = 1.0$ Vdc) CMOS-CMOS ($V_{OL} = 1.5$ Vdc) CMOS-CMOS ($V_{OL} = 1.5$ Vdc) CMOS-CMOS	V_{IL}	5.0	10	-	0.8	-	1.3	0.8	-	0.8	Vdc
		5.0	15	-	0.8	-	1.3	0.8	-	0.8	
		5.0	10	-	1.5	-	2.25	1.5	-	1.4	
		5.0	15	-	1.5	-	2.25	1.5	-	1.5	
		10	15	-	3.0	-	4.5	3.0	-	2.9	
		10	15	-	3.0	-	4.5	3.0	-	2.9	
Input Voltage "1" Level ($V_{OH} = 9.0$ Vdc) TTL-CMOS ($V_{OH} = 13.5$ Vdc) TTL-CMOS ($V_{OH} = 9.0$ Vdc) CMOS-CMOS ($V_{OH} = 13.5$ Vdc) CMOS-CMOS ($V_{OH} = 13.5$ Vdc) CMOS-CMOS	V_{IH}	5.0	10	2.0	-	2.0	1.5	-	2.0	-	Vdc
		5.0	15	2.0	-	2.0	1.5	-	2.0	-	
		5.0	10	3.6	-	3.5	2.75	-	3.5	-	
		5.0	15	3.6	-	3.5	2.75	-	3.5	-	
		10	15	7.1	-	7.0	5.5	-	7.0	-	
		10	15	7.1	-	7.0	5.5	-	7.0	-	
Output Drive Current ($V_{OH} = 2.5$ Vdc) ($V_{OH} = 4.6$ Vdc) ($V_{OH} = 9.5$ Vdc) ($V_{OH} = 13.5$ Vdc) ($V_{OL} = 0.4$ Vdc) ($V_{OL} = 0.5$ Vdc) ($V_{OL} = 1.5$ Vdc)	Source I_{OH}	-	5.0	-3.0	-	-2.4	-4.2	-	-1.7	-	mAdc
		-	5.0	-0.64	-	-0.51	-0.88	-	-0.36	-	
		-	10	-1.6	-	-1.3	-2.25	-	-0.9	-	
		-	15	-4.2	-	-3.4	-8.8	-	-2.4	-	
	Sink I_{OL}	-	5.0	0.64	-	0.51	0.88	-	0.36	-	mAdc
		-	10	1.6	-	1.3	2.25	-	0.9	-	
Input Current	I_{in}	-	15	-	± 0.1	-	± 0.00001	± 0.1	-	± 1.0	μ Adc
Input Capacitance ($V_{in} = 0$)	C_{in}	-	-	-	-	-	5.0	7.5	-	-	pF
Quiescent Current (Per Package) CMOS-CMOS Mode	I_{DD} or I_{CC}	-	5.0	-	0.05	-	0.0005	0.05	-	1.5	μ Adc
		-	10	-	0.10	-	0.0010	0.10	-	3.0	
		-	15	-	0.20	-	0.0015	0.20	-	6.0	
Quiescent Current (Per Package) TTL-CMOS Mode	I_{DD}	5.0	5.0	-	0.5	-	0.0005	0.5	-	3.8	μ Adc
		5.0	10	-	1.0	-	0.0010	1.0	-	7.5	
		5.0	15	-	2.0	-	0.0015	2.0	-	15	
Quiescent Current (Per Package) TTL-CMOS Mode	I_{CC}	5.0	5.0	-	5.0	-	2.5	5.0	-	6.0	mAdc
		5.0	10	-	5.0	-	2.5	5.0	-	6.0	
		5.0	15	-	5.0	-	2.5	5.0	-	6.0	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

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SWITCHING CHARACTERISTICS ($C_L = 50 \text{ pF}$, $T_A = 25^\circ\text{C}$)

Characteristic	Symbol	Shifting Mode	V_{CC} Vdc	V_{DD} Vdc	Limits			Unit
					Min	Typ (Note 3)	Max	
Propagation Delay, High to Low	t_{PHL}	TTL – CMOS $V_{DD} > V_{CC}$	5.0	10	–	140	280	ns
			5.0	15	–	140	280	
		CMOS – CMOS $V_{DD} > V_{CC}$	5.0	10	–	120	240	
			5.0	15	–	120	240	
		CMOS – CMOS $V_{CC} > V_{DD}$	10	5.0	–	185	370	
			15	5.0	–	185	370	
CMOS – CMOS $V_{CC} > V_{DD}$	15	10	–	175	350			
	15	10	–	175	350			
Propagation Delay, Low to High	t_{PLH}	TTL – CMOS $V_{DD} > V_{CC}$	5.0	10	–	170	340	ns
			5.0	15	–	160	320	
		CMOS – CMOS $V_{DD} > V_{CC}$	5.0	10	–	170	340	
			5.0	15	–	170	340	
		CMOS – CMOS $V_{CC} > V_{DD}$	10	5.0	–	275	550	
			15	5.0	–	275	550	
		CMOS – CMOS $V_{CC} > V_{DD}$	15	10	–	145	290	
			15	10	–	145	290	
		Output Rise and Fall Time	t_{TLH} , t_{THL}	ALL	–	5.0	–	
–	10				–	50	100	
–	15				–	40	80	

3. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

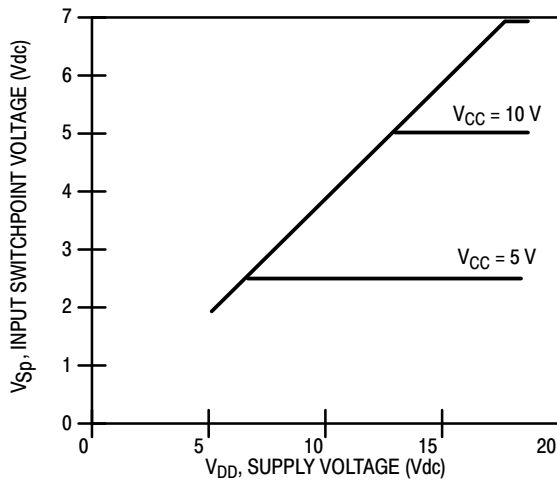


Figure 1. Input Switchpoint CMOS to CMOS Mode

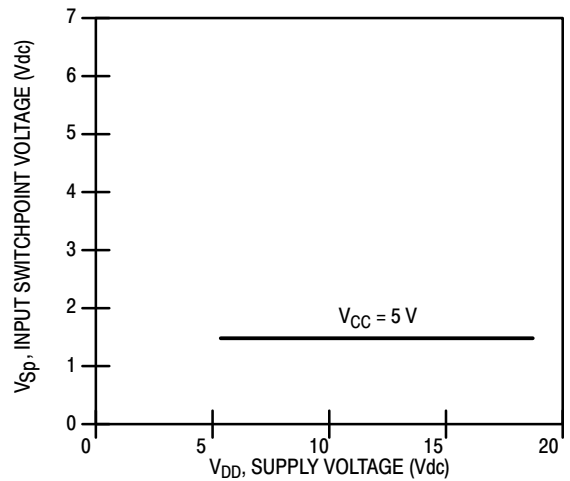


Figure 2. Input Switchpoint TTL to CMOS Mode

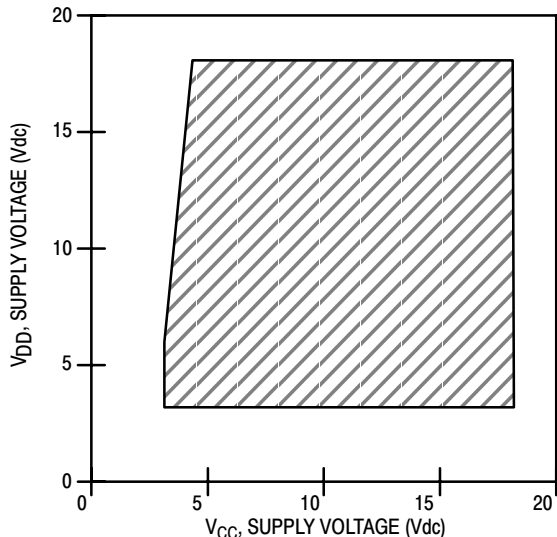


Figure 3. Operating Boundary CMOS to CMOS Mode

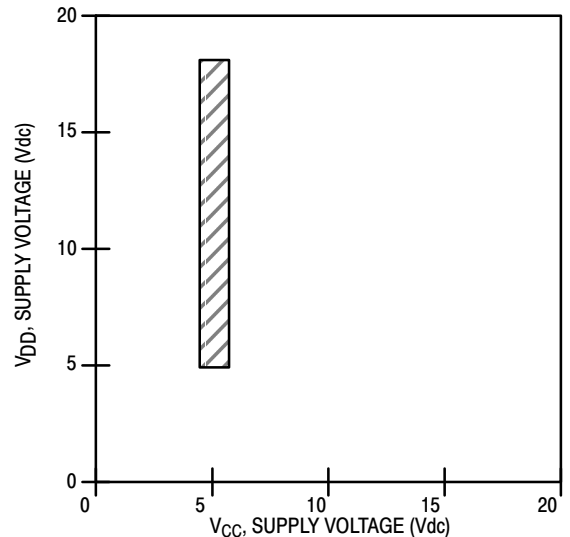
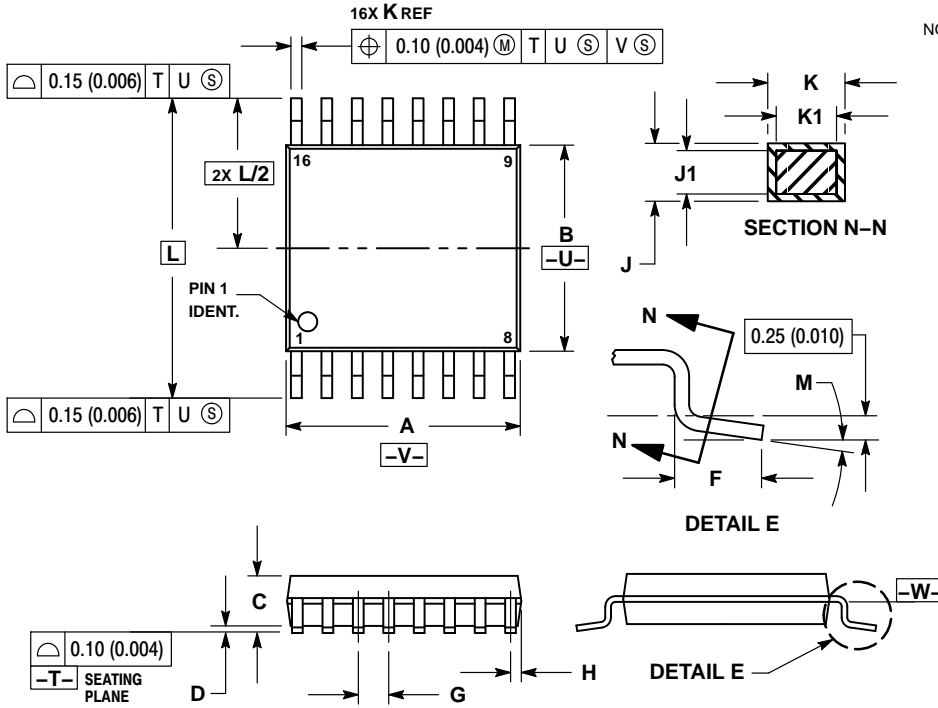


Figure 4. Operating Boundary TTL to CMOS Mode

MC14504B

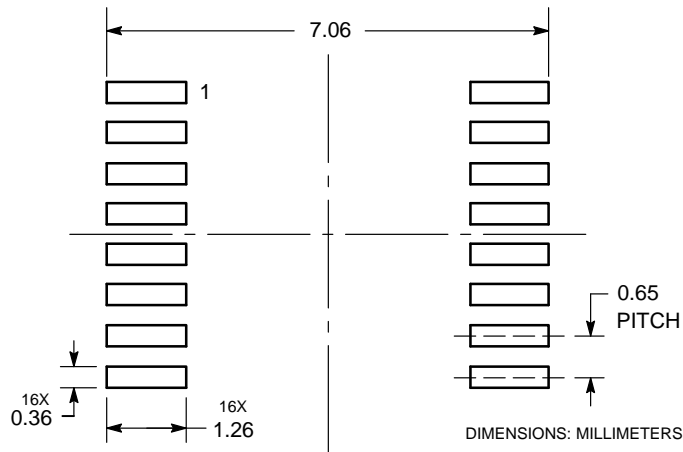
PACKAGE DIMENSIONS

TSSOP-16
DT SUFFIX
PLASTIC TSSOP PACKAGE
CASE 948F
ISSUE B



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

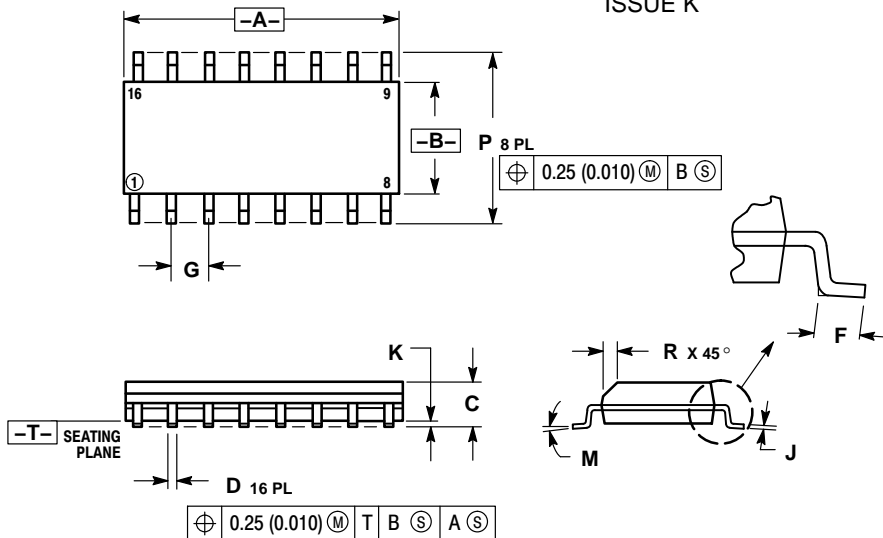
SOLDERING FOOTPRINT



MC14504B

PACKAGE DIMENSIONS

SOIC-16
D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751B-05
ISSUE K

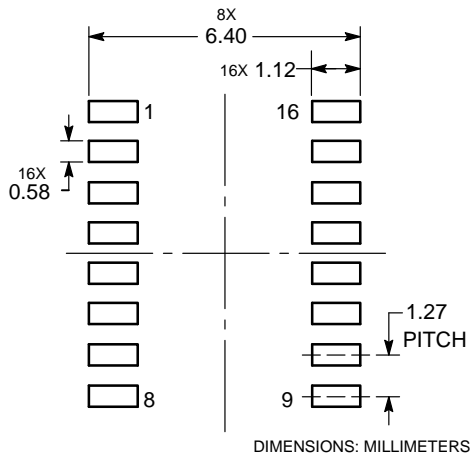


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

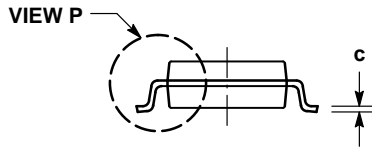
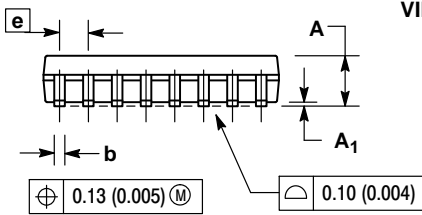
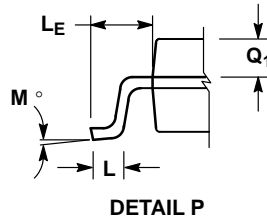
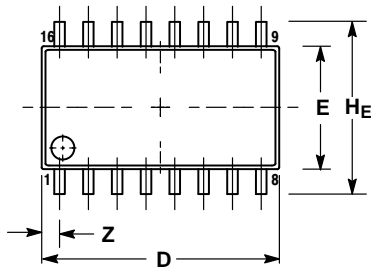
SOLDERING FOOTPRINT



MC14504B

PACKAGE DIMENSIONS


SOEIAJ-16 F SUFFIX PLASTIC EIAJ SOIC PACKAGE CASE 966 ISSUE A



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.10	0.20	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q ₁	0.70	0.90	0.028	0.035
Z	---	0.78	---	0.031

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